



ASEE 2017 INTERNATIONAL FORUM

Columbus, Ohio | June 28, 2017

Call for Papers

The 2017 ASEE International Forum Steering Committee is seeking papers for the 6th Annual ASEE International Forum to be held in conjunction with the 2017 ASEE Annual Conference and Exposition on **Wednesday, June 28, 2017, in Columbus, Ohio.**

The purpose of the International Forum is to bring together engineering professionals from academia and industry from around the globe who are engaged in *novel engineering education initiatives* to share information on successful models, experiences and best practices.

All accepted papers for a paper presentation will be indexed in the ASEE PEER at <https://peer.asee.org/> and in SCOPUS at <http://www.scopus.com/home.url>.

Members of the ASEE community and their global partners are invited to submit abstracts for papers to be presented at the 2017 ASEE International Forum highlighting initiatives, projects, research, trends, programs and partnerships. There is particular interest in engineering education activities involving at least two nations.

The abstracts and subsequent papers will be evaluated by reviewers selected by a Review Committee for quality and best-fit with the aim of planning well-balanced sessions. Papers not selected for a podium presentation may be eligible for a “technical posters” session. The program will include but not limited to two (2) sessions with three (3) parallel tracks each.

At this year's International Forum there will be a special track on **“advanced and digital manufacturing.”** Please indicate your interest in submitting a paper on this topic to Ashok Agrawal (a.agrawal@asee.org).

Papers will be accepted for the following topics:

- Accreditation
- Cross cultural diversity
- Best practices in various approaches
- Student Programs and
- Engineering Education in Developing Nations

Additional topics for papers include but are not limited to:

- International Perspectives on Lifelong Learning
- Difference In Continuing Education In Different Countries
- Successful Partnerships Between Industry and Academia
- Successful Partnerships and Multiple Nations
- Industry Sponsoring Universities and Research
- Effective Models in the U.S. in International Engineering Education
- Effective Models Abroad
- Online Models
- Successful Academic Partnerships between U.S. and International Institutions
- Successful International Academic Partnerships
- Funding Lifelong International Education
- Corporate/Industry Roles
- University Roles
- Third Party Roles
- Personal Roles
- Role Of Licensing Organizations In Lifelong Learning
- Engineering Education for Sustainable Development
- Capstone Design Courses
- Trends and Developments
- Balance of Technology and Student-Instructor Interaction
- International Competitions and Programs

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Important Dates and Deadlines

(All deadlines are 4:59PM Eastern Time):

- October 14, 2016 - Call For Papers
- January 4, 2017 - Registration Opens
- January 22, 2017 - Abstract Submission Closed
- February 17, 2017 - Abstract Decision and Recommendations to Authors
- March 12, 2017 - Final Paper Submissions Due
- April 1, 2017 - Final Paper Review Due
- April 8, 2017 - Notification of Authors
- April 29, 2017 - Final Versions of Papers Due

Submission Guidelines:

Abstracts should follow the ASEE International Forum Abstract Format guidelines found in the 2017 International Forum Author Kit www.asee.org/InternationalForum. The abstract should be sufficiently complete to enable the Program Committee to determine the paper's suitability for presentation at the International Forum.

Review and acceptance is a two-part process for abstracts and full papers. Abstract acceptance does not guarantee acceptance of the paper. Full papers must be accepted and presented by a registered author attending the ASEE International Forum in order to be published in the proceedings. All presentations should be timed for delivery in no more than 15 minutes to allow time for questions and discussion.

All abstracts should be submitted through the Paper Management System on the ASEE home page at www.asee.org. Detailed submission instructions can be found in the 2017 International Forum Author Kit at www.asee.org/InternationalForum.

For additional information please contact Denisha Hedgebeth at d.hedgebeth@asee.org or the committee chair, Howard Appelman, at howard.r.appelman@boeing.com.